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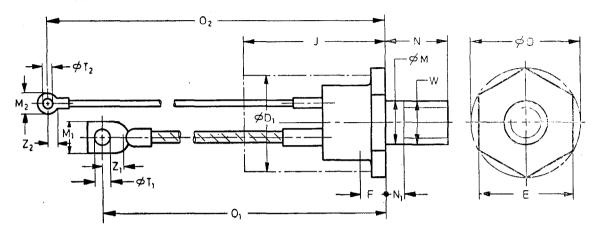




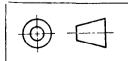
Indian Standard

DIMENSIONS OF SEMICONDUCTOR DEVICES DEVICE OUTLINE OD 39

1. Dimensions — This drawing has been prepared in accordance with IS: 5001 (Part 1)-1969 'Guide for preparation of drawings of semiconductor devices and integrated circuits: Part 1 Semiconductor devices'.



Reference	ence Millimetres			Notes		
	Min	Nom	Max			
φD			20.16			
D,		_		1, 2		
F	2.6	_ ·		_		
J	-	_	50	1, 3		
<i>ф М</i>		_	_	4		
M ₁		_	13.97	5, 6		
М,			7.62	5, 6		
N ₁			2.26			
E	-	17:0				
-O ₁	135		165	7		
O ₂		_	_	7		
φ T ₁			_	10		
φ T ₂	3.5		4.3	_		
W	~	M 8	_	8		
Z ₁	5.0	_	_	9		
Z,	3.2		_	9		



Adopted 4 March 1986

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IS:5000 (OD 39) - 1986

Reference		Type A		Туре В		
	Min	Nom	Max	Min	Nom	Max
N	9.0	_	11.0	13.0		15.0

- Note 1 The device with the exception of the hexagon thread and flexible leads lies within the cylinder of diameter D_1 and length J.
 - Note 2 Diameter D_1 must not be greater than the actual across flats dimensions of the hexagon used.
 - Note 3 J is the seated height with the leads bent at right angles.
 - Note 4 Diameter M refers to zone N_1 . The maximum value should not exceed the outside diameter of the thread.
 - Note 5 The contour and orientation of the terminal slug or lug are undefined.
 - Note 6 The large terminal lug is No. 1, the small terminal lug is No. 2.
 - Note 7 The actual value of dimension O_2 must be greater than that of O_1 .
- Note 8 A clearance hole of 8.5 mm minimum diameter ensures interchangeability between Type A and Type B devices.
 - Note 9 Minimum flat.
 - Note 10 Clearance hole for M5 bolt.
- 2. Rules for Coding See 8.1 of IS: 5001 (Part 1)-1969.

3. Equivalent Designations

Country or Organization	Code	
	Type A	Type B
IEC	A27MA	A27MB
United Kingdom		_
Germany	202A3 △	202B3 >